EVENTS 2020
Content and Networking
Would you like to be informed about the relevant trends and topics of tomorrow? Would you like to be up-to-date and competitive with your knowledge?

In close cooperation with renowned experts and the responsible editorial offices of our well-known media brands, we organise around 50 national and international B2B congresses, seminars and workshops every year for a defined specialist audience.

Our events impart valuable knowledge and facilitate comprehensive networking.
Convince yourself of our quality and bandwidth! Visit our events as a participant, speaker and exhibitor.

- Professional electronics, automation, energy, electrical and ICT
- Congresses, seminars, workshops
- More than 20 years of experience
- 11 B2B editorial offices
- 7,600 participants per year
Exchange with experts!
Meet industry colleagues and like-minded people and take the opportunity to build your professional network

Editorial competence!
Also before and after each event, our editorial offices report in print and online on the topics that are relevant for you

Timeliness!
The constant expansion of our topics guarantees you the most current and relevant information

Strong partners!
Top-class network of speakers, sponsors, exhibitors and multipliers from industry, science and associations

We will be happy to answer any questions you may have regarding presentation submission, participation, sponsoring & trade exhibition. You can find our contact details on page 30 and on the respective event homepage.
## Our events from January to December at a glance

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Subject to change. Current status can be viewed at www.weka-fachmedien.de
The LANline Tech forums take place in a proven manner at various locations in Germany, Austria and Switzerland and are attended by over 1000 people. As established events, they offer an excellent opportunity to discover all about new developments in technology, standardization and products in presentations of technology and products. In addition, there is sufficient time for intensive networking with top-class representatives of the manufacturers as well as with colleagues from the planning, implementation and operation of the cabling infrastructure.

**Criteria for Cabling: Planning, Installation & Operation**

**Top issues:**
- The new version of EN 50173 and ISO/IEC 11801
- Update of standardization and technology of parallel optics
- What categories 8.1 and 8.2 achieve
- Single-pair ethernet in practice
- 40GBase-T and 25GBase-T
- Measurement technology and certification of the new ethernet classes

**Target group:**
Network administrators, IT administrators, installers, network managers, data center managers, planners, infrastructure experts

**Industries:**
Datacenter – Digitization – ICT
Communication – Network Infrastructure
Power Supply – Cabling

**Dates:**
- Tech Forum, Munich: January 28 – 29, 2020
- Tech Forum, Berlin: June 3, 2020
- Tech Forum, Stuttgart: July 7, 2020
- Tech Forum, Hamburg: September 22, 2020
- Tech Forum, Cologne: September 30 – October 1, 2020
- Tech Forum, Vienna: November 3, 2020

**Website:**
www.lanline.de/events/tech-forum/
Enterprise Datacenter in Interaction with Cloud, Hosting & Colocation

Data centers are the heart of today’s businesses and must deliver high performance as well as meet ever-increasing energy and cost efficiency requirements. To achieve this, those managers for both the procurement of infrastructure and its operation need specialist knowledge. The Datacenter Symposium brings data center specialists and managers up to date with the latest know-how - independent, highly informative and particularly practical. Experts, industry insiders and data center operators come together here. High-class lectures and workshops will serve this purpose.

Top issues:
- Energy efficiency in data centers
- Effects of EN 50600 and ISO/IEC 22237 on planning and operation
- DCIM, Monitoring, AIM
- Cooling, free cooling, adiabatic
- Fire protection, alerting, physical security
- Modern power supply technology

Target group:
Computer center specialists and responsible persons

Industries:
- Datacenter – Digitization – ICT
- Communication – Air Conditioning – Cooling – Monitoring – Safety & Security
- Power Supply

Dates:
- Datacenter Symposium, Hanau: February 19, 2020
- Datacenter Symposium, Berlin: June 4, 2020
- Datacenter Symposium, Stuttgart: July 8, 2020
- Datacenter Symposium, Munich: September 15 – 16, 2020
- Datacenter Symposium, Cologne: October 1, 2020

Website:
www.lanline.de/events/datacenter-symposium
BatteryWorld revolves around all challenges around the entire value and supply chain of rechargeable batteries. We want to cover the entire spectrum from supply security of essential raw materials such as lithium, cell chemistry, cells and their production, the engineering of battery packs as well as the diverse applications to Second Life and recycling.

**Date:**
January 28 – 29, 2020 in Munich

**Website:**
www.battery-world.de

**Top issues:**
- Electromobility
- Home storage
- Portable electronics

**Target group:**
Manufacturers, users, energy suppliers, industry, commerce, battery consultants, mobility providers, start-ups, university employees

**Industries:**
Automotive – Industrial Electronics
Power Supply

**Conference language is German**

Takes place in parallel to the Forum Power Architectures!
Products, Concepts and Solutions

Among other things, electronics developers have the task of designing a power supply for the system to be developed. Since the power sector is often not one of their core competencies, the power supply solution is not developed in-house but purchased. The event is intended to convey the most important basics about power supplies and DC/DC converters so that electronics developers and technical buyers from the application areas of industry, medicine and smart house (building services engineering) can make a qualified preselection on the basis of the data sheet of a power supply and ask the power supply manufacturer the appropriate further questions.

Date:
January 28 – 29, 2020 in Munich

Website:
www.forum-power-architectures.de

Top issues:
- Architectures (central or distributed power supply)
- Static and dynamic characteristic values
- Thermal characteristic values (derating) and concepts
- Environmental influences due to temperature, climate, shock and vibration
- Special features such as "Extra Power" and "Selective Fuse Breaking"
- Galvanic isolation and amplified galvanic isolation
- Electromagnetic compatibility

Target group:
Electronics developers and technical buyers from industrial electronics, embedded systems

Industries:
Industrial-Electronics – Embedded Power Supply

Conference language is German

Takes place in parallel to BatteryWorld!

Hosts:

Partners:
Powerful Network for the Car of Tomorrow

Autonomous driving is not possible without a strong vehicle network such as Automotive Ethernet. The Automotive Ethernet Congress, taking place for the sixth time this year, provides a comprehensive overview of the wide range of technical innovations. Practice-oriented contributions will provide well-founded specialist knowledge for all those who want to tap and exploit the full potential of Automotive Ethernet. Last but not least, workshops will give participants the opportunity to discuss and possibly solve a problem in small groups.

Top issues:
- Basic knowledge for ethernet users
- The integration of ethernet into the overall network
- Physical layer
- Interoperability tests
- AVB and TSN in practice
- Use cases: New applications for ethernet

Target group:
Engineers and system architects of network technologies and communication, software engineers, ECU testers, decision makers at OEMs and Tier 1s

Industries:
Automotive – Embedded – Communication

Date:
February 12 – 13, 2020 in Munich

Website:
www.automotive-ethernet-congress.de
Meeting point for the Community

The conference is an essential part of the dynamic environment of the embedded world, which over the years has developed into an international meeting place for the professional embedded developer community. Here, experienced developers come together to share their knowledge and help others turn their ideas and inventions into real products.

**Top issues:**
- Internet of things – platforms & applications
- Connected systems
- Embedded OS
- Safety & Security
- Hardware engineering
- Software & systems engineering
- Embedded vision
- Autonomous & intelligent systems
- Embedded Graphics & HMI
- System-on-Chip (SoC)/Design & Development

**Date:**
February 25 – 27, 2020
Exhibition Centre Nuremberg

**Website:**
www.embedded-world.eu

**Target group:**
Hardware/software developers, system designers, suppliers and users of test systems, scientific and research institutions, technical buyers, practical users

**Industries:**
Automation – Automotive – Digitization
Embedded – ICT – Communication
Safety & Security

**Hosts:**

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![Embedded World Logo](Logo.png)

**Exhibition Conference**
...it's a smarter world

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NÜRNBERG MESSE
The Most Important European B2B Platform for Display Technologies

The 34th electronic displays Conference (edC) serves to present innovative ideas, approaches, developments and research projects in the field of today’s and tomorrow’s display business. The conference enables the exchange of the latest advances and information between engineers, experts, users, researchers, dealers, consultants and manufacturers working in the field of modern electronic displays and their applications.

Date:
February 26 – 27, 2020
Exhibition Centre Nuremberg

Website:
www.electronic-displays.de

Top issues:
• Display technologies
• Display applications
• Driving and interfaces
• Touch screens
• GUI
• HMI
• 3D
• Measurement tasks
• System aspects and integration of components
• Display subassemblies
• Supply chain
• Market data
• Lighting

Target group:
Engineers, users, researchers, traders, consultants, manufacturers

Industries:
Automotive – Displays – Embedded – ICT

Hosts:

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Artificial intelligence has become the focus of many technical developments. AI, machine learning and neural networks are key technologies that enable systems to react autonomously and make decisions based on external influences. The Artificial Intelligence Forum will examine the rapid developments in hardware and software.

**Top issues:**
- AI in embedded-systems: Hardware and software-components for the design of AI-systems
- AI in automotive and telematics: Autonomous driving, traffic control, Safety & Security
- AI in the factory: Machine learning, predictive maintenance, optimization of working environment and production

**Target group:**
Product manager as well as hardware and software developer. Users, for example, in the field of automation technology or in machine and plant construction. Embedded system designers of self-learning systems.

**Industries:**
Automotive – Digitization – Embedded ICT

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Machine Learning – Deep Learning – Neuronal Networks

Dates:
May 14, 2020 in Stuttgart

Website:
www.forum-ki.eu

Conference language is German
Systems that directly affect humans must be functionally safe. The fact that these systems often also have to be secure is made clear by the hacker attacks that are becoming more and more common. Which problems and solutions these aspects, and, in addition, the interaction of both of them, bring with themselves, is discussed in the forum Safety & Security.

**Date:**  
June 22 – 24, 2020 in Stuttgart  
**Website:**  
www.safety-security-forum.de

**Top issues:**  
- Basics  
- Hardware and software tools  
- Automotive  
- Industry  
- Medicine

**Target group:**  
Hardware and software developers, integrators, manufacturers, designers, developers and users, functional safety engineers/managers, security experts, auditors, certification managers, test managers, test engineers, quality assurance experts

**Industries:**  
Automation – Automotive  
Digitization – Embedded – Safety & Security
Passive for Professionals

The user forum is intended to provide circuit developers and technical purchasers with the most important basics on passive components so that they can become safer and more familiar when dealing with capacitors and the like. The event will mainly be held in German. In terms of application technology, it is primarily dedicated to the use of passive components in the fields of industrial electronics, medical technology, renewable energies and automotive. At the accompanying trade exhibition, manufacturers and service providers present their latest products and interesting applications and are available for intensive discussions.

Date:
July 1 – 2, 2020 in Munich

Website:
www.passive-anwenderforum.de

Top issues:
- Types of resistors, capacitors and inductors
- Material and design characteristics (frequency, temperature and voltage dependence)
- Electromagnetic compatibility
- Interaction with active components and ICs
- Standards
- Case studies
- Optimization of the supply chain (allocation)

Target group:
Electronics developers, system developers and technical buyers from the industrial electronics, embedded systems and automotive sectors

Industries:
Automation – Automotive
Renewable Energies – Industrial Electronics
Medical Engineering

Conference language is German

Hosts:
Markt&Technik
DESIGN & ELEKTRONIK
Understanding and Implementing EMC in Practice

At the first „User Forum EMV“ organized by Markt&Technik and DESIGN&ELEKTORNIK, we want to give developers practical assistance in dealing with electromagnetic compatibility. We want to help them to create EMC-compatible circuit designs, to understand and localize sources of interference, to get a grip on interference emissions and develop effective shielding concepts.

Date:
July 02, 2020 in Munich

Website:
www.emv-anwenderforum.de

Top issues:
• Basics of EMV
• EMC-compliant design (circuit board, subsystem, overall system)
• EMC components
• Casing technologies
• Shielding
• Measurement technology
• Antenna technology
• Certification

Target group:
Electronics developers, system developers and technical buyers from the following areas Industrial electronics, embedded systems and automotive

Industries:
Automation – Automotive
Renewable Energies – Industrial Electronics
Medical Technology

Hosts:
Design & Elektronik
Markt & Technik

Conference language is German
From technical specialists to operators, consultants, industry experts and cloud and digitisation experts - IT has become the elementary basis of countless business processes and with it the role that system houses and managed service providers have to play is changing. But those who see this change as an opportunity can position themselves as a strong partner and indispensable consultant at their customers’ side in the course of digitization.

The CRN Channel Conference 2020 brings together in one event the most important topics and developments that determine the business of system houses and managed service providers and shows the greatest potential of an industry in rapid change.

Exchange ideas with strategy and technology experts and experience top-class speakers in numerous keynotes and breakout sessions on successful concepts for the IT business of the future - each on a highly exciting day, in Fürstenfeldbruck, Essen and Vienna.

Top issues:
- Business cloud
- Managed services
- Security
- Storage
- Network management
- Internet of things
- Big data & analytics

Target group:
Exclusive target group of up to 100 participants (system houses/IT service providers, MSPs/hosts, system integrators, IT consultants, value added distributors)

Industry:
ICT

Dates:
September 17, 2020 in Fuerstenfeldbruck
October 15, 2020 in Essen
November 5, 2020 in Vienna

Website:
www.channel-konferenz.de

Conference language is German

Host:
CRN

Partners:
No Matter How the Vehicle Changes – the On-board Network Remains

More than 90 percent of vehicle innovations today are determined by electronics. These electronic functions require a powerful backbone that supplies them with power and networks for data exchange. This must keep pace with current developments, such as the increased electrification of the powertrain, the increasing internal and external networking and the trend towards autonomous driving. The Wiring Harness Congress will cover all relevant aspects of partitioning current E/E architectures and the implementation of wiring systems.

Date:
September 22, 2020 in Landshut

Website:
www.bordnetz-kongress.de

Top issues:
• Concept of an E/E architecture for autonomous vehicles
• Requirements for the future wiring system/development of wiring systems
• Quality assurance of data from topology development
• Requirements management and processes
• Functional safety and reliability
• Verification, validation and safeguarding

Target group:
Wiring Harness developers and engineers at OEMs and Tier N suppliers, developers of automotive cables and connectors, system integrators and development managers at OEMs and Tier N suppliers, scientists from research and teaching in the automotive field

Industries:
Automotive – Communication
Power Supply
Industrial – Automotive – Audio/Video

Time Sensitive Networking – TSN – provides standard ethernet with a standardized real-time extension. TSN will have a far-reaching influence, especially on the industrial, automotive and audio/video/consumer segments. The TSN/A Conference will highlight the technological aspects of the standard as well as application-relevant topics in the three user industries.

Date:
October 7 – 8, 2020 in Frankfurt

Website:
www.tsnaconference.de

Top issues:
- The IEEE 802 standards for time sensitive networks (TSN)
- 5G in combination with TSN in industrial applications
- Edge/Fog Computing in combination with TSN, OPC UA and 5G
- TSN - Activities in the chip market
- TSN and Open Source
- Safety critical distributed systems via TSN

Target group:
Developers and suppliers of automation components and devices, mechanical engineers, automotive suppliers and manufacturers, manufacturers from the audio/video/consumer world

Industries:
Automation – Automotive – ICT
Digitization – Communication
Safety & Security

Host:

In cooperation with:
Automotive SerDes

The very first Automotive SerDes Conference will take place in Munich on October 13th, 2020.
In-vehicle cameras and displays are often connected to the image-processing ECU via a SerDes (serializer/deserializer) connection. The SerDes market is characterized by double-digit growth rates as new applications are continuously emerging. The Automotive SerDes Conference will provide a comprehensive overview of the current and upcoming market situation within the entire SerDes environment – from proprietary solutions to new standards (ASA/MIPI) to asymmetric Ethernet.

Top issues:
- Fundamentals for SerDes users
- Markets and strategies
- Physical layer / data link layer
- Security: efficient protection
- Compliance / interoperability
- Tools and test methods
- Use cases; new possibilities for SerDes use
- Architecture: connecting SerDes to the IVN

Target group:
Automotive

Industries:
Automation – Automotive – ICT
Digitization – Communication
Safety & Security
Sensors for the modern vehicle

What are the advantages and disadvantages of the different sensor types and technologies? The aim of the user forum „Automotive Sensor Technology“ is to provide the user from the field of automotive electronics with suggestions and tips.

For circuit and system developers, the user forum is intended to provide both basic information and application tips in order to become safer and more familiar with sensors in the future and to be able to fully exploit the potential of the various sensor technologies for the respective application in the vehicle.

Top-issues:
- Application examples
- Data processing
- Sensor technologies

Target group:
Users and developers receive detailed information and practical tips for the use of sensors in vehicles.

Industries:
Automotive

Date:
October 14, 2020 in Munich

Website:
www.automotive-sensorik.de

Host:
Markt&Technik
Everything about IoT Applications and Platforms

After the Internet of Things had long been regarded as a vision for the future, concrete applications are picking up speed more and more. Developers are challenged to realize the building blocks of this comprehensive network. This is only possible with suitable techniques, methods and standards, from connectivity to security, software and tools. The path of data from the sensor to the cloud and back also depends on architectures and the distribution of applications, as well as integrated ecosystems and services, data models and the semantics of the transmitted data values.

Date:
October 20 - 21, 2020 in Stuttgart

Website:
www.iot-konferenz.de

Top-issues:
- Security at the IoT
- IoT Best Practices
- Methods & Tools
- AI/Machine Learning
- Retrofit
- Connectivity

Target group:
Hardware developers, software developers, system designers, suppliers along the value chain, scientific and research institutions, technical buyers, practical users

Industries:
Digitization – Embedded – ICT

Conference language is German
From the Requirements Analysis to the Finished HMI

In a Human Machine Interfaces (HMI)s many requirements meet: networking, platform independence, security, voice input, augmented reality... Find out at the HMI developer forum how to plan and implement your HMI project and benefit from the experience of long-standing experts.

Date:
October 21, 2020 in Stuttgart

Website:
www.iot-konferenz.de

Top issues:
• HMI development for industrial applications
• HMI modular system or individual software?
• Platform independence
• Security Ergonomics
• HMI requirement analysis
• HMI hardware
• Multimodal human-machine interfaces
• Intelligent Assistant

Target group:
Device designer, developer, product manager, project manager, technical management

Industries:
Automation, consumer electronics, automotive, plant and mechanical engineering, building services engineering, medical technology, aerospace, quality assurance

Hosts:

Conference language is German
Design the Workplace of the Future

More than just theory: The Digital Workplace Forum makes the workplace of the future tangible in an innovative and interactive event format. In practice-oriented workshops and campfire sessions you will not only learn what the digital and networked working world can do, but above all how to successfully equip your ICT infrastructure, processes and employees for New Work. At the Digital Workplace Forum, the focus is on the exchange at eye level between users, technology experts and innovation drivers, as well as on knowledge transfer in dialogue.

Date:
October 22, 2020 in Fuerstenfeldbruck

Website:
www.digital-workplace-forum.de

Top issues:
• Digital workplace strategies
• Unified communications & collaboration
• Private, hybrid- and public cloud models
• Mobile work
• Data protection and compliance
• Safety concepts
• Change management and employee development
• Big data, VR, machine learning, AI: What will the future bring?

Target group:
CEOs, CIOs, CDOs, CTOs, IT managers, IT and TC administrators, system houses, value added resellers

Industries:
ICT user companies from all-industries

Conference language is German

Host:
funkschau

In cooperation with:
Power semiconductors are core components of any power supply, DC/DC converter or inverter. However, the market for MOSFET, IGBT & Co. is almost unmanageable in terms of individual favorites. At the Power Semiconductors User Forum, developers and technical purchasers receive practical assistance on how to move more safely in this field and find the best solution for their respective project.

**Top issues:**
- Types of power semiconductors (MOSFET, IGBT, modules, SiC, GaN)
- Internal structure of power semiconductors
- Housing types
- Failure mechanisms, reliability and ageing
- Losses and heat dissipation
- Wiring
- Electromagnetic compatibility
- Interaction with other components

**Target group:**
Electronics developers and technical buyers from the industrial electronics, embedded systems and automotive sectors

**Industries:**
Automation – Automotive
Industrial Electronics – Safety & Security
Power Supply

**Date:**
October 28 - 29, 2020 in Munich

**Website:**
www.leistungshalbleiter-anwenderforum.de
Next Generation Wireless Networks

It is fascinating to be able to retrieve information at any time and any place. The associated mobile use of the Internet has brought a boom to mobile network operators. This success story should now become a model for more and more professional applications, in industry, in the automobile, in medical technology, etc. The Internet of Things and Industry 4.0 are only two drivers of the current development. Low costs in the development and operation of wireless applications make wireless technologies economically interesting for mass applications.

Date:
Nov 11 - 12, 2020 in Munich

Website:
www.wireless-congress.com

Top issues:
- Mobile radio technologies and M2M
- Low-power radio technologies
- Radio and radio sensor networks
- Reliability, security and protection in wireless networks
- Energy self-sufficient radio nodes and energy harvesting
- Radio communication technologies with low latency – for automation technology, use in automobiles, tactile Internet
- Standardisation, interoperability and conformity

Target group:
Developers of radio systems and terminals with radio interface, software developers for radio applications, system developers and product managers, system integrators and professional users, suppliers of wireless systems and components, QM and compliance managers, product designers

Industries:
Automotive – Automation
Digitization – Embedded – ICT
Communication – Safety & Security

Hosts:
Medical Electronics in the Field of Tension between Innovations and Regulations

For the 3rd time already, the electronica Medical Electronics Conference (eMEC) offers a platform for the mutual exchange between the electronics industry and medical technology manufacturers.

In addition to classic lectures, innovative discussion formats, in particular, are intended to promote interdisciplinary exchange.

The eMEC 2020 will show that not only the new EU-MDR and the consequences of the broadband will occupy the industries, but above all innovations in manufacturing, digitalization and miniaturization.

These range from AI-supported imaging to smart assistants for homecare applications and intelligent, active implants.

Date:
November 10, 2020 in Munich

Website:
www.medical-electronics-conference.de

Top issues:
- Smart Medical Devices
- Self-determination of medical data
- Microsystem diagnostics
- Collaborative Robotics
- Virtual Medicine
- Big Data
- New sensor concepts
- Usability
- Cyber Security
- Smart Monitoring
- Artificial Intelligence
- Telemedicine
- Surgery 4.0

Target group:
Hardware and software developers, engineers, decision-makers, scientists and physicians involved in the development and application of medical electronics, medical buyers and representatives of health insurance companies who want to obtain first-hand information about trends in medical electronics.

Industries:
Medical & Healthcare Technology
Electronics
Parallel to SPS

Accompanying the SPS - Smart Production Solutions - the editorial offices of WEKA FACHMEDIEN are organising the Automation 4.0 Summit in Nuremberg for the sixth time.

Date:
November 24 – 25, 2020
Exhibition Centre Nuremberg

Website:
www.automation-40.de

Conference language
is German

Top issues:
• 5G, TSN and OPC UA in the industry
• IoT platforms and Best Practices
• Cost-effective automation by robotics?
• Securely connected: from the sensor to the cloud

Target group:
Specialists and executives from automation technology, manufacturing industry, asset engineering and mechanical engineering

Industries:
Automation – Automotive – Embedded

Takes place in parallel to SPS – Smart Production Solutions!

Hosts:

Partner:
Seminars & Workshops

With our proven seminars series “Training for Professionals” and LANline-Workshops we offer a quick introduction to new techniques. Here, competent and experienced trainers impart the necessary specialist knowledge in intensive seminars, usually lasting several days, so that the participants can use the learned techniques directly and successfully in their own projects. Practical examples, often also the possibility of trying out what has been learned directly in the seminar, and the opportunity to ask the experts questions are essential success factors of this series of events.

The current topics and dates can be found here:
www.weka-fachmedien.de

Top issues Training for Professionals:
We offer further seminars among others on the following topics.
- Embedded Linux
- EMV
- Yocto
- Intely

Top issues LANline-Workshops:
- Certification course WLAN
- EMV
- Future-oriented cabling concepts
- Fiber optic transmission technology
- Workshops on new EN standards

Conference language is German

Hosts:
Event Team

Thomas Ebert
HEAD OF EVENT
P +49 89 25556-1713
tebert@weka-fachmedien.de

Renate Ester
EVENT MANAGER
P +49 89 25556-1349
rester@weka-fachmedien.de

Lucie Rösgen-Pomper
EVENT MANAGER
P +49 89 25556-1610
lroesgen@weka-fachmedien.de

Katrin Scheinig
EVENT MANAGER
P +49 89 25556-1062
kscheinig@weka-fachmedien.de

Nina Thonesen
EVENT MANAGER
P +49 89 25556-1323
nthonesen@weka-fachmedien.de

Corina Prell
SALES MANAGER EVENTS
P +49 89 25556-1393
cprell@weka-fachmedien.de

Elena Sämann
SALES COORDINATOR EVENTS
P +49 89 25556-1359
esaemann@weka-fachmedien.de

Lana Büchele
COORDINATOR CONFERENCE ATTENDEES
P +49 89 25556-1611
lbuechele@weka-fachmedien.de

Juliane Heger
SENIOR COORDINATOR CONFERENCE ATTENDEES
P +49 89 25556-1155
jheger@weka-fachmedien.de

Laura Lermer
COORDINATOR CONFERENCE ATTENDEES
P +49 89 25556-1725
llermer@weka-fachmedien.de
Would you like to bring your products and solutions closer to your target group in a relaxed setting? Do you attach importance to your external image in front of potential customers?

Present your company to the participants of our events at the accompanying trade exhibition. Show your products and solutions to a competent and interested audience.

Become an exhibitor at the WEKA FACHMEDIEN events!

- 100% professional audience
- Tailor-made exhibitor- and sponsoring packages
- 230 Exhibitors & Sponsors every year
- Cross-media communication

Excerpt from our exhibitors and sponsors:
<table>
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<th>Valuable contacts!</th>
<th>No coverage waste!</th>
<th>Show competence!</th>
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<tr>
<td>Meet your potential customers on site</td>
<td>The clear focus of the event ensures „that only the audience who is interested in the topic is present“</td>
<td>Demonstrate your products and solutions</td>
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<th>Cross-media communication!</th>
<th>Personal address!</th>
<th>Strong corporate image!</th>
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<tr>
<td>From Call for Papers to post-event reporting: We accompany every event around the clock in print and online</td>
<td>Meet participants and speakers in a relaxed atmosphere</td>
<td>Deepen the awareness level of your company</td>
</tr>
</tbody>
</table>

We will be happy to answer any questions you may have regarding presentation submission, participation, sponsoring & trade exhibition. You can find our contact details on page 30 and on the respective event homepage.